1410187-4 - ACTIVE

MULTIGIG RT | MULTIGIG RT 2

TE Internal #: 1410187-4 High Speed Backplane Connectors, 112 Position, Mating Alignment, Polarization Mating Alignment Type, 7 Row, 16 Column, PCB Mount Header, MULTIGIG RT 2

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: Board-to-Board Number of Positions: 112 Row-to-Row Spacing: 1.35 mm [.053 in] Mating Alignment: With Mating Alignment Type: Polarization

Features

Product Type Features

Applied to Printed Circuit Board Type

Connector System

Daughtercard

Board-to-Board

PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Card Slot Centerline	20.3 mm[.8 in]
Backplane Architecture	Traditional Backplane
Number of Positions	112
Number of Rows	7
Number of Columns	16
PCB Mount Orientation	Right Angle
Guide Location	Center
Contact Features	
Contact Current Rating (Max)	1 A
Mechanical Attachment	
Mating Alignment	With

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Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	2
Centerline (Pitch)	1.8 mm[.071 in]
Dimensions	
Row-to-Row Spacing	1.35 mm[.053 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

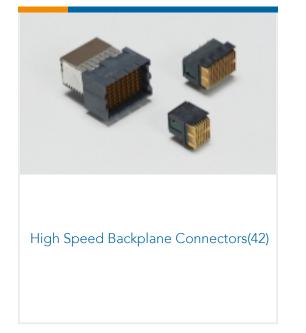
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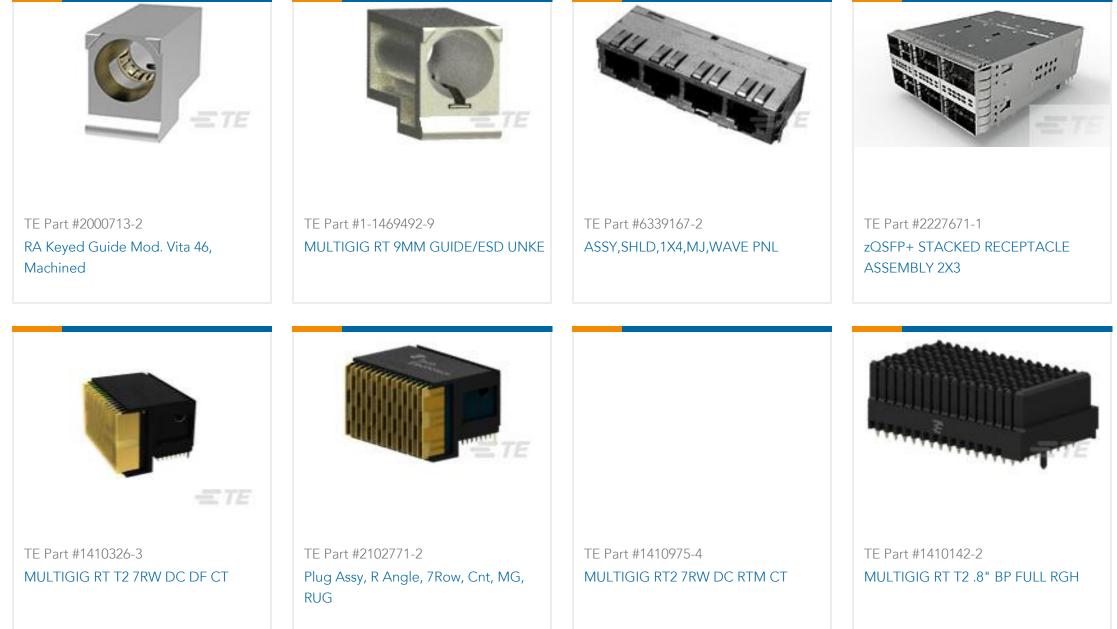


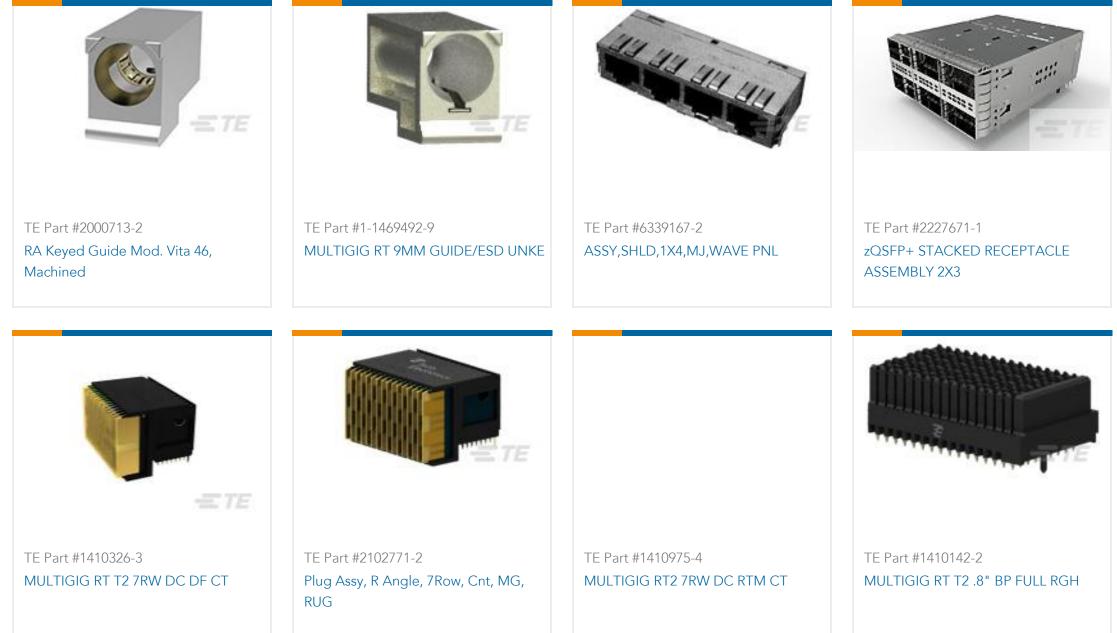


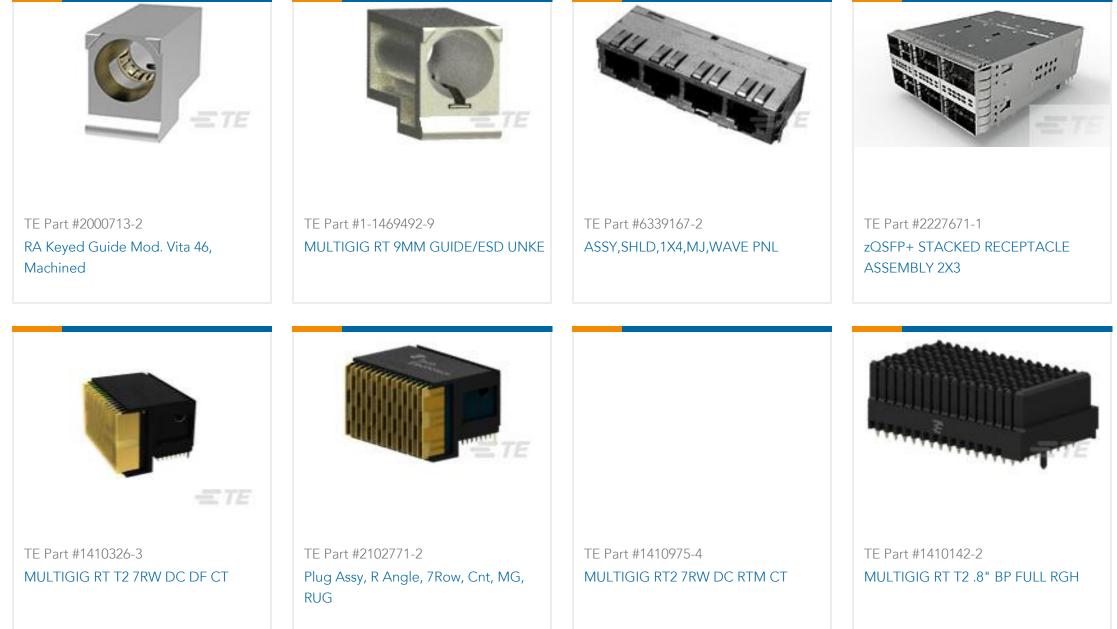
Also in the Series | MULTIGIG RT 2

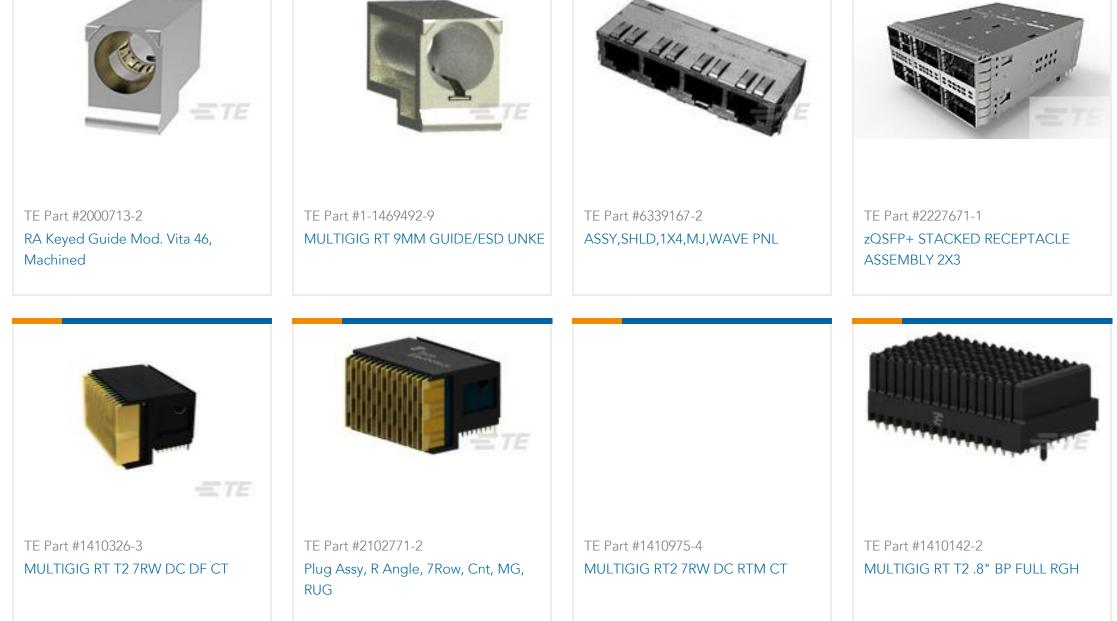


Customers Also Bought









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Documents

Product Drawings MULTIGIG RT T2 7RW DC DF CT

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1410187-4_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1410187-4_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1410187-4_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Board-Level Interconnects for Rugged Embedded Computing Brochure

English

Product Specifications Electrical Performance Report

English

Product Environmental Compliance MD_1410187-4_12142017155_dmtec

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